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TRANSISTORS, HIGH VOLTAGE, NPN

**BASED ON TYPE 2N3439 AND 2N3440** 

ESCC Detail Specification No. 5203/011

Issue 5 October 2020





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# **DOCUMENTATION CHANGE NOTICE**

(Refer to https://escies.org for ESCC DCR content)

DCR No.	CHANGE DESCRIPTION
1365	Specification updated to incorporate changes per DCR.



# ESCC Detail Specification

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# 1 **GENERAL**

## 1.1 SCOPE

This specification details the ratings, physical and electrical characteristics and test and inspection data for the component type variants and/or the range of components specified below. It supplements the requirements of, and shall be read in conjunction with, the ESCC Generic Specification listed under Applicable Documents.

#### 1.2 APPLICABLE DOCUMENTS

The following documents form part of this specification and shall be read in conjunction with it:

- (a) ESCC Generic Specification No. 5000
- (b) MIL-STD-750, Test Methods and Procedures for Semiconductor Devices

#### 1.3 TERMS, DEFINITIONS, ABBREVIATIONS, SYMBOLS AND UNITS

For the purpose of this specification, the terms, definitions, abbreviations, symbols and units specified in ESCC Basic Specification No. 21300 shall apply.

## 1.4 THE ESCC COMPONENT NUMBER AND COMPONENT TYPE VARIANTS

## 1.4.1 The ESCC Component Number

The ESCC Component Number shall be constituted as follows:

Example: 520301101

Detail Specification Reference: 5203011

Component Type Variant Number: 01 (as required)

## 1.4.2 <u>Component Type Variants</u>

The component type variants applicable to this specification are as follows:

Variant Number	Based on Type	Case	Lead/Terminal Material and Finish	Weight max g
01	2N3439	TO-5	D2	1.5
02	2N3439	TO-39	D2	1.5
03	2N3439	TO-5	D3 or D4	1.5
04	2N3439	TO-39	D3 or D4	1.5
05	2N3440	TO-5	D2	1.5
06	2N3440	TO-39	D2	1.5
07	2N3440	TO-5	D3 or D4	1.5
08	2N3440	TO-39	D3 or D4	1.5

The lead/terminal material and finish shall be in accordance with the requirements of ESCC Basic Specification No. 23500.



## 1.5 <u>MAXIMUM RATINGS</u>

The maximum ratings shall not be exceeded at any time during use or storage.

Maximum ratings shall only be exceeded during testing to the extent specified in this specification and when stipulated in Test Methods and Procedures of the ESCC Generic Specification.

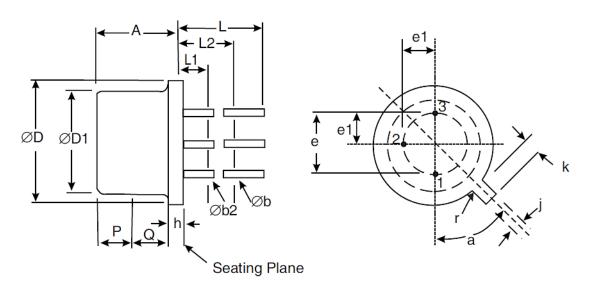
Characteristics	Symbols	Maximum Ratings	Unit	Remarks
Collector-Base Voltage Variants 01 to 04 Variants 05 to 08	V <sub>CBO</sub>	450 300	V	Over T <sub>op</sub>
Collector-Emitter Voltage Variants 01 to 04 Variants 05 to 08	V <sub>CEO</sub>	350 250	V	Over T <sub>op</sub>
Emitter-Base Voltage	V <sub>EBO</sub>	7	V	Over T <sub>op</sub>
Collector Current	lc	1	Α	
Power Dissipation	P <sub>tot1</sub>	800	mW	At T <sub>amb</sub> ≤ +25°C
	P <sub>tot2</sub>	5	W	At T <sub>case</sub> ≤ +25°C
Thermal Resistance, Junction-to-Ambient	R <sub>th(j-a)</sub>	218.8	°C/W	
Thermal Resistance, Junction-to-Case	R <sub>th(j-c)</sub>	35	°C/W	
Operating Temperature Range	Top	-65 to +200	°C	Note 1
Storage Temperature Range	T <sub>stg</sub>	-65 to +200	°C	Note 1
Soldering Temperature	T <sub>sol</sub>	+260	°C	Note 2

- For Variants with tin-lead plating or hot solder dip lead finish all testing, and any handling, performed at T<sub>amb</sub> > +125°C shall be carried out in a 100% inert atmosphere.
- 2. Duration 10 seconds maximum at a distance of not less than 1.5mm from the device body and the same lead shall not be resoldered until 3 minutes have elapsed.



#### 1.6 PHYSICAL DIMENSIONS AND TERMINAL IDENTIFICATION

#### 1.6.1 Metal Can Package (TO-5) - 3 lead



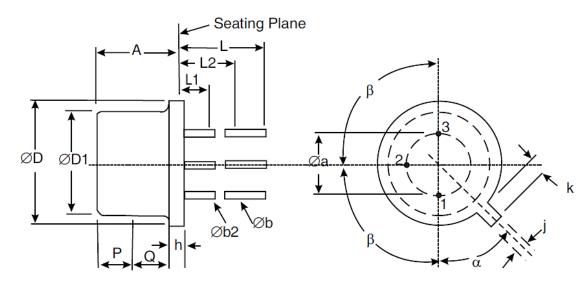
Symbolo	Dimensi	Notes	
Symbols	Min	Max	Notes
Α	6.1	6.6	
Øb	0.406	0.533	2, 3
Øb2	0.406	0.483	2, 3
ØD	8.51	9.4	
ØD1	7.75	8.51	
е	5.08	BSC	6
e1	2.54 BSC		
h	0.229	3.18	
j	0.711	0.864	
k	0.737	1.14	4
L	38.1	-	2
L1	-	1.27	2, 3
L2	6.35	-	2, 3
Р	2.54	-	5
Q	-	-	7
r	-	0.179	8
а	45° l	BSC	1,9

- Terminal identification is specified by reference to the tab position where Lead 1 = emitter, 1. Lead 2 = base and Lead 3 = collector.
- 2. Applies to all leads.
- Øb2 applies between L1 and L2. Øb applies between L2 and 38.1mm from the seating 3. plane. Diameter is uncontrolled within L1 and beyond 38.1mm from the seating plane.
- 4. Measured from the maximum diameter of the actual device.



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- 5. This zone is controlled for automatic handling. The variation in actual diameter within this zone shall not exceed 0.254mm.
- 6. Leads having maximum diameter 0.483mm measured in the gauging plane 1.37 (+0.025, -0) mm below the seating plane of the device shall be within 0.178mm of their true position relative to a maximum-width-tab.
- 7. The details of outline in this zone are optional.
- 8. Radius.
- 9. Measured from the tab centreline.

## 1.6.2 Metal Can Package (TO-39) - 3 lead



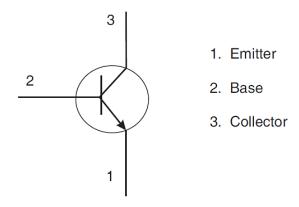
Symbols	Dimens	Notes	
Symbols	Min	Max	Notes
Øa	4.83	5.35	
А	6	6.6	
Øb	0.4	0.533	2, 3
Øb2	0.4	0.483	2, 3
ØD	8.31	9.4	
ØD1	7.75	8.51	5
h	0.229	3.18	
j	0.711	0.864	
k	0.737	1.14	4
L	12.7	19	2
L1	-	1.27	2, 3
L2	6.35	-	2, 3
Р	2.54	-	5
Q	-	-	6
α	45°	BSC	1, 7
β	90°	BSC	1



#### NOTES:

- Terminal identification is specified by reference to the tab position where Lead 1 = emitter, Lead 2 = base and Lead 3 = collector.
- 2. Applies to all leads.
- 3. Øb2 applies between L1 and L2. Øb applies between L2 and 12.7mm from the seating plane. Diameter is uncontrolled within L1 and beyond 12.7mm from the seating plane.
- 4. Measured from the maximum diameter of the actual device.
- 5. This zone is controlled for automatic handling. The variation in actual diameter within this zone shall not exceed 0.254mm.
- 6. The details of outline in this zone are optional.
- 7. Measured from the tab centreline.

#### 1.7 FUNCTIONAL DIAGRAM



#### **NOTES:**

1. The collector is internally connected to the case.

## 1.8 MATERIALS AND FINISHES

Materials and finishes shall be as follows:

- (a) Case
  - The case shall be hermetically sealed and have a metal body with hard glass seals.
- (b) Leads/Terminals
  As specified in Para. 1.4.2, Component Type Variants.

#### 2 REQUIREMENTS

#### 2.1 GENERAL

The complete requirements for procurement of the components specified herein are as stated in this specification and the ESCC Generic Specification. Permitted deviations from the Generic Specification, applicable to this specification only, are listed below.

Permitted deviations from the Generic Specification and this Detail Specification, formally agreed with specific Manufacturers on the basis that the alternative requirements are equivalent to the ESCC requirement and do not affect the component's reliability, are listed in the appendices attached to this specification.



#### 2.1.1 **Deviations from the Generic Specification**

#### 2.1.1.1 Deviation from Screening Tests - Chart F3

High Temperature Reverse Bias Burn-in and the subsequent Final Measurements for HTRB shall be omitted.

#### 2.2 MARKING

The marking shall be in accordance with the requirements of ESCC Basic Specification No. 21700 and as follows.

The information to be marked on the component shall be:

- (a) The ESCC qualified components symbol (for ESCC qualified components only).
- (b) The ESCC Component Number (see Para. 1.4.1).
- Traceability information. (c)

#### 2.3 **TERMINAL STRENGTH**

The test conditions for terminal strength, tested as specified in the ESCC Generic Specification, shall be as follows:

Test Condition: E, lead fatigue.

#### 2.4 ELECTRICAL MEASUREMENTS AT ROOM, HIGH AND LOW TEMPERATURES

Electrical measurements shall be performed at room, high and low temperatures.

#### Room Temperature Electrical Measurements 2.4.1

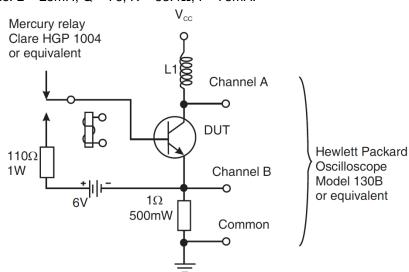
The measurements shall be performed at  $T_{amb} = +22 \pm 3^{\circ}C$ .

Characteristics	Symbols	MIL-STD-750			nits	Units
		Test Method		Min	Max	
Collector-Base Breakdown Voltage	V <sub>(BR)</sub> CBO	3001	Ic = 100µA Bias condition D Variants 01 to 04	450	-	V
			Variants 05 to 08	300	-	
Collector-Emitter Sustaining Voltage	VCEO(sus)	-	I <sub>B</sub> = 5mA Variants 01 to 04 Variants 05 to 08 Note 4	350 250	-	V
Emitter-Base Breakdown Voltage	V <sub>(BR)EBO</sub>	3026	I <sub>B</sub> = 1mA Bias condition D	7	1	V
Collector-Emitter Cut-off Current	ICEX	3041	Bias condition A Variants 01 to 04: $V_{CE} = 450V$ , $V_{BE} = -1.5V$ Variants 05 to 08: $V_{CE} = 300V$ , $V_{BE} = -1.5V$	-	500	μА



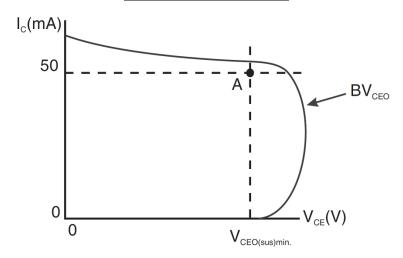
Characteristics			MIL-STD-750 Test Conditions		Limits	
		Test Method		Min	Max	
Collector-Base Cut-off Current	Ісво	3036	Bias condition D Variants 01 to 04: V <sub>CB</sub> = 360V Variants 05 to 08: V <sub>CB</sub> = 250V	-	20	μА
Emitter-Base Cut- off Current	I <sub>EBO</sub>	3061	V <sub>EB</sub> = 6V Bias condition D	-	20	μΑ
Forward-Current Transfer Ratio	h <sub>FE1</sub>	3076	V <sub>CE</sub> = 10V, I <sub>C</sub> = 20mA Note 1	40	160	-
	h <sub>FE2</sub>	3076	V <sub>CE</sub> = 10V, I <sub>C</sub> = 2mA Note 1	30	-	-
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	3071	I <sub>C</sub> = 50mA, I <sub>B</sub> = 4mA Notes 1, 2	-	500	mV
Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub>	3066	I <sub>C</sub> = 50mA, I <sub>B</sub> = 4mA Test Condition A Notes 1, 2	-	1.3	V
Magnitude of Small-Signal Short-Circuit Forward-Current Transfer Ratio	h <sub>fe</sub>	3306	$V_{CE} = 10V$ , $I_{C} = 10mA$ f = 5MHz Note 3	3	15	-
Output Capacitance	Cobo	3236	V <sub>CB</sub> = 10V, I <sub>E</sub> = 0A f = 1MHz Note 3	-	10	pF

- 1. Pulsed measurement: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 2. Saturation voltage is measured 6mm from the case.
- 3. For AC characteristics read and record measurements shall be performed on a sample of 32 components with 0 failures allowed. Alternatively a 100% inspection may be performed.
- 4.  $V_{CEO(sus)}$  shall be measured using the test circuit shown below.  $V_{CC} = 0V$  to 60V, pulsed, Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ .  $I_{CC} = 100mA$ . Inductor L1 shall have the following characteristics: L = 25mH, Q = 76, R = 83.4 $\Omega$ , I = 75mA.





# OSCILLOSCOPE DISPLAY



B<sub>VCEO</sub> is acceptable if the trace is both to the right of, and above, point A, as shown.

# 2.4.2 <u>High and Low Temperatures Electrical Measurements</u>

Characteristics	Symbols	MIL-STD-750	Test Conditions	Lin	nits	Units
		Test Method	Note 1	Min	Max	
Collector-Base Cut- off Current	Ісво	3036	$T_{amb}$ = +150 (+0 -5)°C Bias condition D Variants 01 to 04: $V_{CB}$ = 360V Variants 05 to 08: $V_{CB}$ = 250V	-	500	μA
Forward-Current Transfer Ratio 1	h <sub>FE1</sub>	3076	T <sub>amb</sub> = -55 (+5 -0)°C V <sub>CE</sub> = 10V, I <sub>C</sub> = 20mA Note 2	20	-	-

- 1. Read and record measurements shall be performed on a sample of 5 components with 0 failures allowed. Alternatively a 100% inspection may be performed.
- 2. Pulsed measurement: Pulse Width ≤ 300µs, Duty Cycle ± 2%.



## 2.5 PARAMETER DRIFT VALUES

Unless otherwise specified, the measurements shall be performed at  $T_{amb} = +22 \pm 3$ °C.

The test methods and test conditions shall be as per the corresponding test defined in Para. 2.4.1, Room Temperature Electrical Measurements.

The drift values ( $\Delta$ ) shall not be exceeded for each characteristic specified. The corresponding absolute limit values for each characteristic shall not be exceeded.

Characteristics	Symbols		Limits		Units
		Drift	Absolute		
		Value Δ	Min	Max	
Collector-Base Cut-off Current	I <sub>CBO</sub>	±4	-	20	μΑ
Forward-Current Transfer Ratio 1	h <sub>FE1</sub>	±20%	40	160	-
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	±50	-	500	mV

## 2.6 INTERMEDIATE AND END-POINT ELECTRICAL MEASUREMENTS

Unless otherwise specified, the measurements shall be performed at  $T_{amb} = +22 \pm 3$ °C.

The test methods and test conditions shall be as per the corresponding test defined in Para. 2.4.1, Room Temperature Electrical Measurements.

The limit values for each characteristic shall not be exceeded.

Characteristics	Symbols	Limits		Units
		Min	Max	
Collector-Base Cut-off Current	Ісво	-	20	μΑ
Forward-Current Transfer Ratio 1	h <sub>FE1</sub>	40	160	-
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	-	500	mV

# 2.7 POWER BURN-IN CONDITIONS

OWER BORN IN COMBINIONS			
Characteristics	Symbols	Test Conditions	Units
Ambient Temperature	T <sub>amb</sub>	+25 (+0 -5)	°C
Power Dissipation	P <sub>tot</sub>	800	mW
Collector-Emitter Voltage Variants 01, 02, 03, 04 Variants 05, 06, 07, 08	V <sub>CE</sub>	250 180	V

#### NOTES:

1. No heat sink or forced air directly on the device shall be permitted.



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# 2.8 OPERATING LIFE CONDITIONS

The conditions shall be as specified in Para. 2.7, Power Burn-in Conditions.



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# APPENDIX 'A' AGREED DEVIATIONS FOR STMICROELECTRONICS (F)

ITEMS AFFECTED	DESCRIPTION OF DEVIATIONS
Para. 2.1.1, Deviations from the Generic Specification: Para. 8, Test Methods and Procedures	<ul> <li>For qualification and qualification maintenance, or procurement of qualified or unqualified components, the following replacement test method specifications shall be used instead of the following ESCC Basic Specifications:</li> <li>No. 20400, Internal Visual Inspection: replaced by MIL-STD-750 Test Method 2072.</li> <li>No. 20500, External Visual Inspection: replaced by MIL-STD-750 Test Method 2071.</li> <li>No. 20900, Radiographic Inspection of Electronic Components: replaced by MIL-STD-750 Test Method 2076.</li> </ul>
Para. 2.1.1.1, Deviations from the Generic Specification: Deviations from Screening Tests - Chart F3	Solderability is not applicable unless specifically stipulated in the Purchase Order.
Para. 2.4.1, Room Temperature Electrical Measurements	All AC characteristics (Para. 2.4.1, Note 2) may be considered guaranteed but not tested if successful pilot lot testing has been performed on the wafer lot which includes AC characteristic measurements per the Detail Specification.
	A summary of the pilot lot testing shall be provided if required by the Purchase Order.
Para. 2.4.2, High and Low Temperatures Electrical Measurements	All characteristics specified may be considered guaranteed but not tested if successful pilot lot testing has been performed on the wafer lot which includes characteristic measurements at high and low temperatures per the Detail Specification.
	A summary of the pilot lot testing shall be provided if required by the Purchase Order.